

January 1991 Revised May 2002

MM74C192 • MM74C193 Synchronous 4-Bit Up/Down Decade Counter • Synchronous 4-Bit Up/Down Binary Counter

General Description

The MM74C192 and MM74C193 up/down counters are monolithic complementary MOS (CMOS) integrated circuits. The MM74C192 is a BCD counter, while the MM74C193 is a binary counter.

Counting up and counting down is performed by two count inputs, one being held high while the other is clocked. The outputs change on the positive-going transition of this clock.

These counters feature preset inputs that are set when load is a logical "0" and a clear which forces all outputs to "0" when it is at a logical "1". The counters also have carry and borrow outputs so that they can be cascaded using no external circuitry.

Features

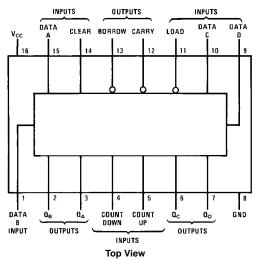
- High noise margin: 1V guaranteed
- Tenth power TTL compatible: Drive 2 LPTTL loads
- Wide supply range: 3V to 15V
- Carry and borrow outputs for N-bit cascading
- Asynchronous clear
- High noise immunity: 0.45 V_{CC} (typ.)

Ordering Code:

Order Number Package Number Package Description						
	MM74C192N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide			
	MM74C193M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow			
	MM74C193N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide			

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Connection Diagram



Absolute Maximum Ratings(Note 1)

 $\begin{tabular}{lll} Voltage at Any Pin & -0.3V to V_{CC} + 0.3V \\ Operating Temperature Range (T_A) & -55^{\circ}C to +125^{\circ}C \\ Storage Temperature Range (T_S) & -65^{\circ}C to +150^{\circ}C \\ Maximum V_{CC} Voltage & 18V \\ \end{tabular}$

Power Dissipation (P_D)

Dual-In-Line 700 mW Small Outline 500 mW

Operating V_{CC} Range 3V to 15V

Lead Temperature (T_A)

(Soldering, 10 seconds) 260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristics table provides conditions for actual device operation.

DC Electrical Characteristics

Min/Max limits apply across temperature range unless otherwise noted

Symbol	Parameter	Conditions	Min	Тур	Max	Units
CMOS TO	смоѕ				•	
V _{IN(1)}	Logical "1" Input Voltage	V _{CC} = 5V	3.5			V
		$V_{CC} = 10V$	8.0			
V _{IN(0)}	Logical "0" Input Voltage	V _{CC} = 5V			1.5	V
		V _{CC} = 10V			2.0	
V _{OUT(1)}	Logical "1" Output Voltage	$V_{CC} = 5V$, $I_{O} = -10 \mu A$	4.5			V
		$V_{CC} = 10V, I_{O} = -10 \mu A$	9.0			
V _{OUT(0)}	Logical "0" Output Voltage	$V_{CC} = 5V$, $I_{O} = 10 \mu A$			0.5	V
		$V_{CC}=10V,I_O=10~\mu A$			1.0	v
I _{IN(1)}	Logical "1" Input Current	V _{CC} = 15V, V _{IN} = 15V		0.005	1.0	μΑ
I _{IN(0)}	Logical "0" Input Current	V _{CC} = 15V, V _{IN} = 0V	-1.0	-0.005		μΑ
I _{CC}	Supply Current	V _{CC} = 15V		0.05	300	μΑ
CMOS TO	LPTTL INTERFACE					
V _{IN(1)}	Logical "1" Input Voltage	V _{CC} = 4.75V	V _{CC} – 1.5			V
V _{IN(0)}	Logical "0" Input Voltage	V _{CC} = 4.75V			0.8	V
V _{OUT(1)}	Logical "1" Output Voltage	$V_{CC} = 4.75V$, $I_{O} = -100 \mu A$	2.4			V
V _{OUT(0)}	Logical "0" Output Voltage	$V_{CC} = 4.75V, I_{O} = 360 \mu A$			0.4	V
OUTPUT D	RIVE (See Family Characteristics	Data Sheet) (Short Circuit Current)				
I _{SOURCE}	Output Source Current	$V_{CC} = 5V, V_{IN(0)} = 0V$	-1.75	1.75		mA
		$T_A = 25$ °C, $V_{OUT} = 0$ V	-1.75			
I _{SOURCE}	Output Source Current	$V_{CC} = 10V, V_{IN(0)} = 0V$	-8			mA
		$T_A = 25$ °C, $V_{OUT} = 0V$	_0			111/5
I _{SINK}	Output Sink Current	$V_{CC} = 5V, V_{IN(1)} = 5V$	1.75			mA
		$T_A = 25$ °C, $V_{OUT} = V_{CC}$	1.75			
I _{SINK}	Output Sink Current	$V_{CC} = 10V, V_{IN(1)} = 10V$	8	8		mA
		$T_A = 25$ °C, $V_{OUT} = V_{CC}$				

AC Electrical Characteristics (Note 2)

 $T_A=25^{\circ}C,\ C_L$ = 50 pF, unless otherwise noted

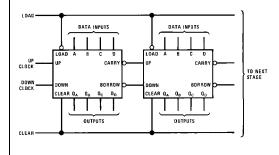
Symbol	Parameter	Conditions	Min	Тур	Max	Units	
t _{pd}	Propagation Delay	V _{CC} = 5V		250	400	ns	
	Time to Q from Count Up or Down	V _{CC} = 10V		100	160	ns	
t _{pd}	Propagation Delay	V _{CC} = 5V		120	200		
	Time to Q Borrow from Count Down	V _{CC} = 10V		50	80	ns	
t _{pd}	Propagation Delay	V _{CC} = 5V		120	200		
	Time to Carry from Count Up	V _{CC} = 10V		50	80	ns	
t _S	Time Prior to Load	V _{CC} = 5V		100	160		
	that Data Must be Present	V _{CC} = 10V		30	50	ns	
t _W	Minimum Clear Pulse Width	V _{CC} = 5V	300 480				
		V _{CC} = 10V		120	190	ns	
t _W	Minimum Load Pulse Width	V _{CC} = 5V		100	160	160 65	
		V _{CC} = 10V		40	65		
t _{pd0}	Propagation Delay	V _{CC} = 5V		300	480	ns	
t _{pd1}	Time to Q from Load	V _{CC} = 10V		120	190	115	
t _W	Minimum Count Pulse Width	V _{CC} = 5V		120	200	ns	
		V _{CC} = 10V		35	80		
f _{MAX}	Maximum Count Frequency	V _{CC} = 5V	2.5	4		MHz	
		V _{CC} = 10V	6	10			
t _r	Count Rise and Fall Time	V _{CC} = 5V			15		
t _f		V _{CC} = 10V			5	μs	
C _{IN}	Input Capacitance	(Note 3)		5		pF	
C _{PD}	Power Dissipation Capacitance	(Note 4)		100		pF	

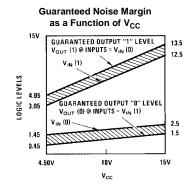
Note 2: AC Parameters are guaranteed by DC correlated testing.

Note 3: Capacitance is guaranteed by periodic testing.

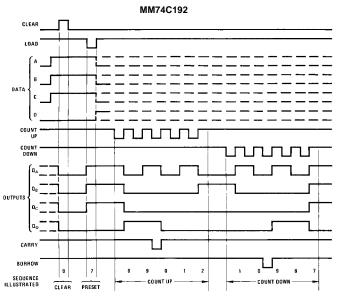
Note 4: CPD determines the no load AC power consumption of any CMOS device. For complete explanation, see Application Note AN-90.

Cascading Packages





Timing Diagrams

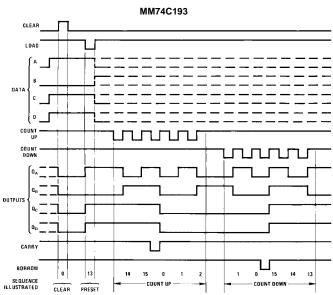


Note A: Clear outputs to zero.

Note B: Load (preset) to binary thirteen.

Note C: Count up to fourteen, fifteen, carry, zero, one and two.

Note D: Count down to one, zero, borrow, fifteen, fourteen, and thirteen.



Note A: Clear outputs to zero.

Note B: Load (preset) to BCD seven.

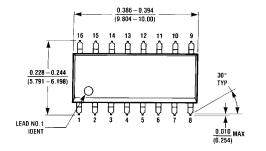
Note C: Count up to eight, nine, carry, zero, one, and two.

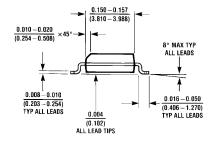
 $\textbf{Note D:} \ \ \text{Count down to one, zero, borrow, nine, eight, and seven.}$

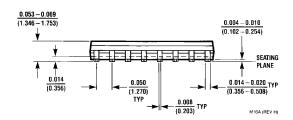
Note E: Clear overrides load, data, and count inputs.

 $\textbf{Note F:} \ \textbf{When counting up, count down input must be HIGH; when counting down, count-up input must be HIGH.}$





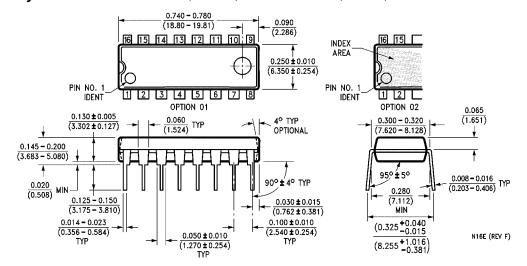




16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow Package Number M16A

Counter

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N16E

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